

Psec-Resolution Time-of-Flight Detectors T979

Argonne, Chicago, Fermilab, Hawaii, Saclay/IRFU, SLAC

Camden Ertley
University of Chicago
All Experimenters Meeting
July 14, 2008
(Bastille Day!)

T979 People/Institutions

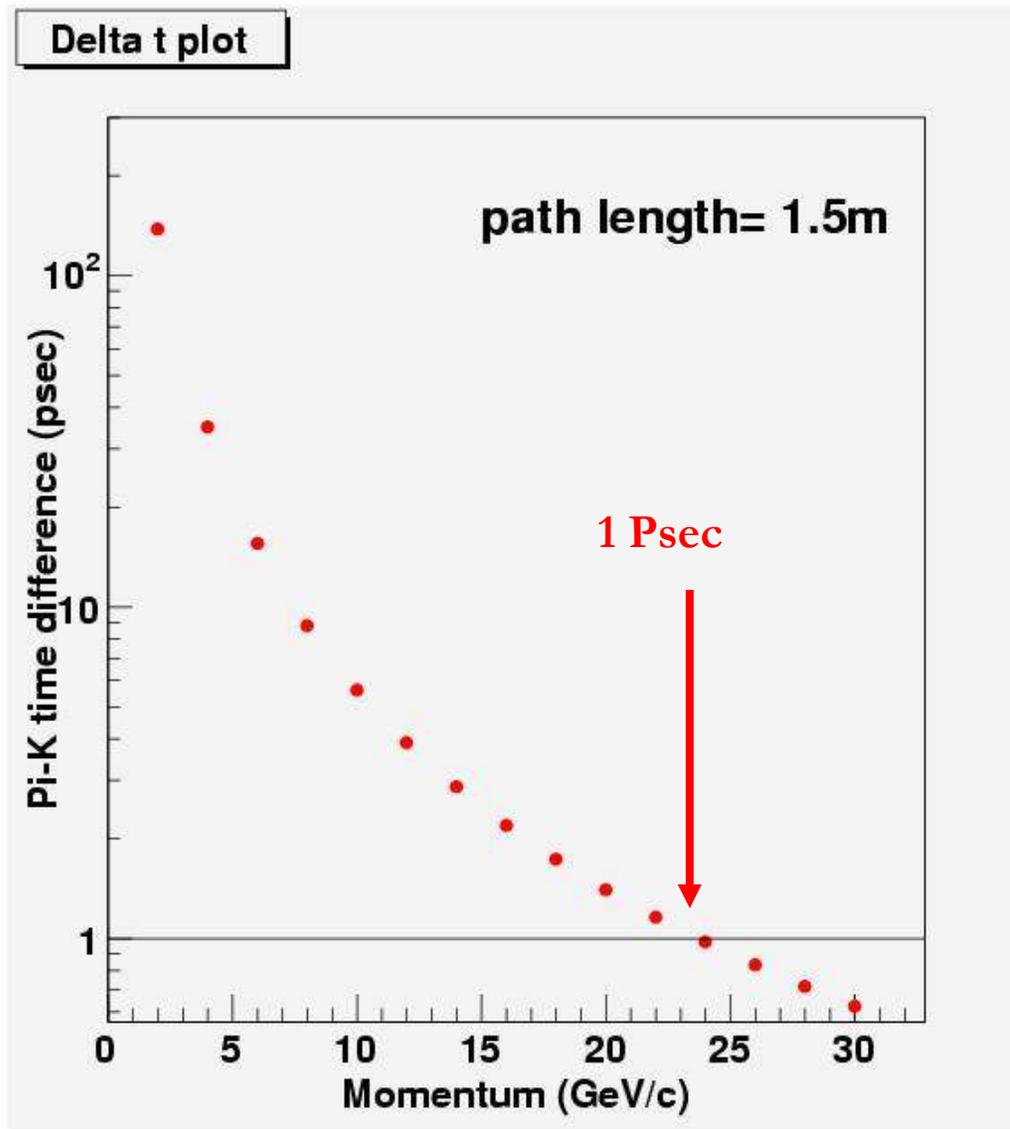
- Argonne National Laboratory
 - John Anderson, Karen Byrum, Gary Drake, Ed May
- University of Chicago
 - Camden Ertley, Henry Frisch, Heejong Kim, Jean-Francois Genat, Andrew Kobach, Tyler Natoli, Fukun Tang, Scott Wilbur
- Fermilab
 - Michael Albrow, Erik Ramberg, Anatoly Ronzhin, Greg Sellberg
- Saclay/IRFU
 - Emilien Chapon, Patrick LeDu, Christophe Royon
- Hawaii
 - Gary Varner
- SLAC
 - Jerry Va'vra



Motivation- Following the quarks

- A substantial fraction of the HEP community has converged on a small number of collider experiments- Atlas, CMS, ILC
- Budget > 1 billion \$/year
- Output is 3-vectors for most particles, plus parton type (e,mu,tau,b,c,..) for some- there is still some fundamental information we could get, and need.
- Worth the investment to identify the kaons, charmed particles, b's, ...- go to 4-vectors. Nothing more left for charged particles!
- Possible other application- photon-vertexing. Add converter in front- know velocity, with transit-time vertex photons. (e.g. $H \rightarrow gg$, LHCb, $K \rightarrow \pi \nu \nu$).
- Serious long-term detector R&D will pay off in many fields- one example- H. Nicholson- proposed use of high-res time/pos in DUSEL water-Cherenkov full coverage. Great education for young folks too!
- MTest is a key facility for the future of the field. We appreciate it!

K-Pi Separation over 1.5m



Assumes perfect momentum resolution (time res is better than momentum res!)

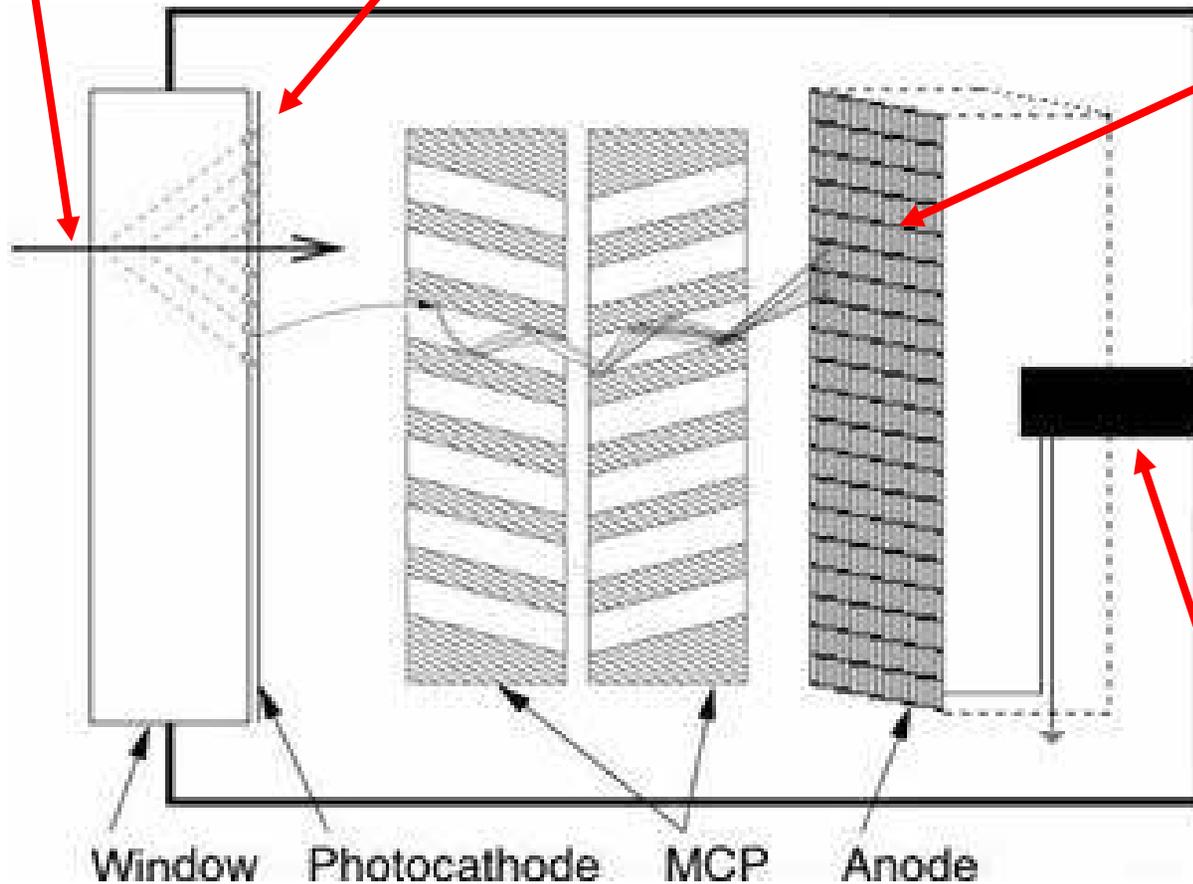
Characteristics we need

- Feature size $< \sim 300$ microns
- Homogeneity -ability to make uniform large-area – e.g. 30 m^2 for CDF-III or ATLAS
- Fast rise-time and/or constant signal shape
- Lifetime (rad hard in some cases, but not all)
- System cost \ll silicon micro-vertex system

Idea 1: Generating the signal

Use Cherenkov light: fast, directional

Incoming rel. particle



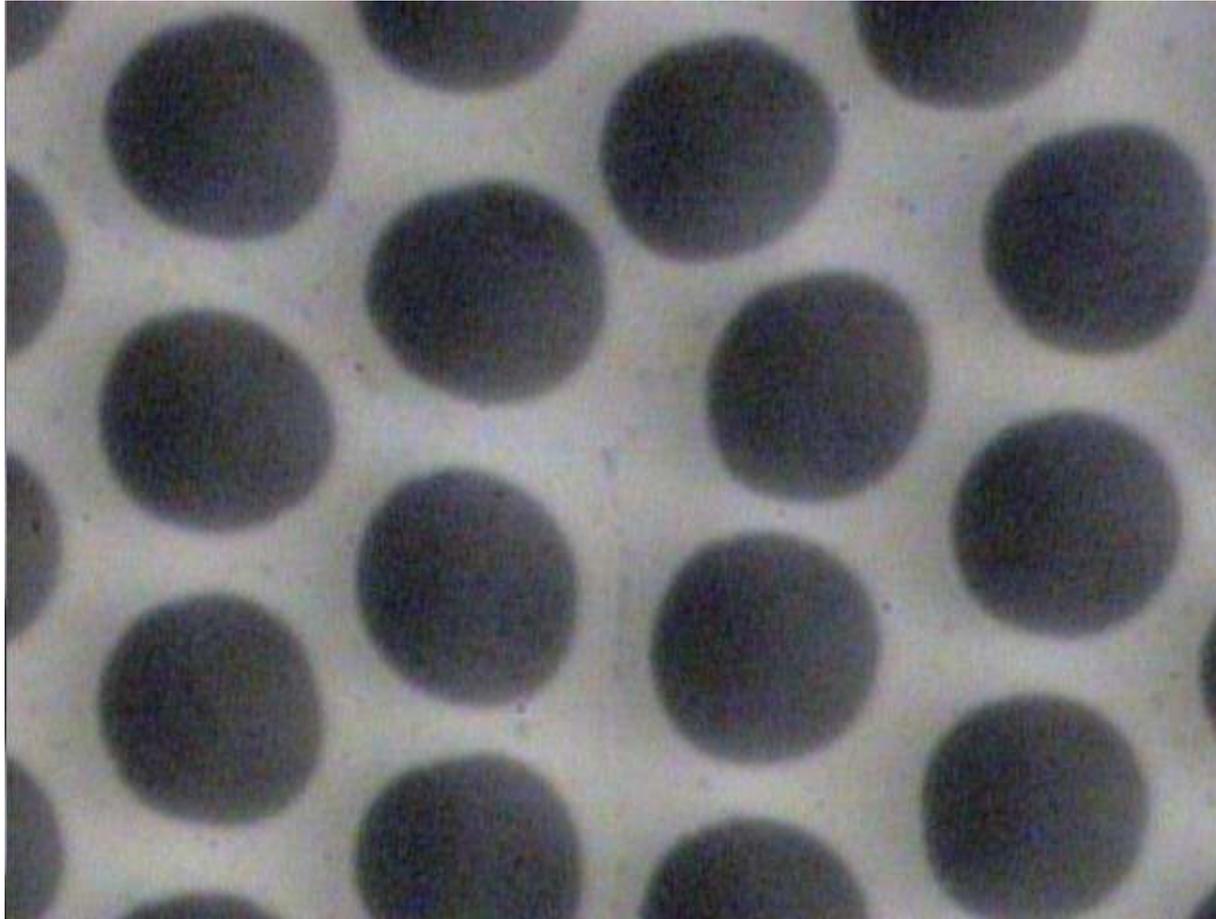
Custom Anode with
Equal-Time Transmission
Lines + Capacitive. Return

A 2" x 2" MCP-
actual thickness
~3/4"

e.g. Burle
(Photonis) 85022-
with mods per
our work

Collect charge here-differential
Input to 200 GHz TDC chip

Major advance for TOF measurements:



**Micro-
photograph of
Burle 25
micron tube-
Greg Sellberg
(Fermilab)**

1. Development of MCP's with 2-10 micron pores
2. Transmission line anodes
3. Sampling electronics

Simulation and Measurement

- **Have started a serious effort on simulation to optimize detectors and integrated electronics**
- **Use laser test-stands and MTEST beam to develop and validate understanding of individual contributions- e.g. Npe, S/N, spectral response, anode to input characteristics,...**
- **Parallel efforts in simulating sampling electronics (UC, Hawaii) and detectors (UC,Saclay,Muons.inc).**

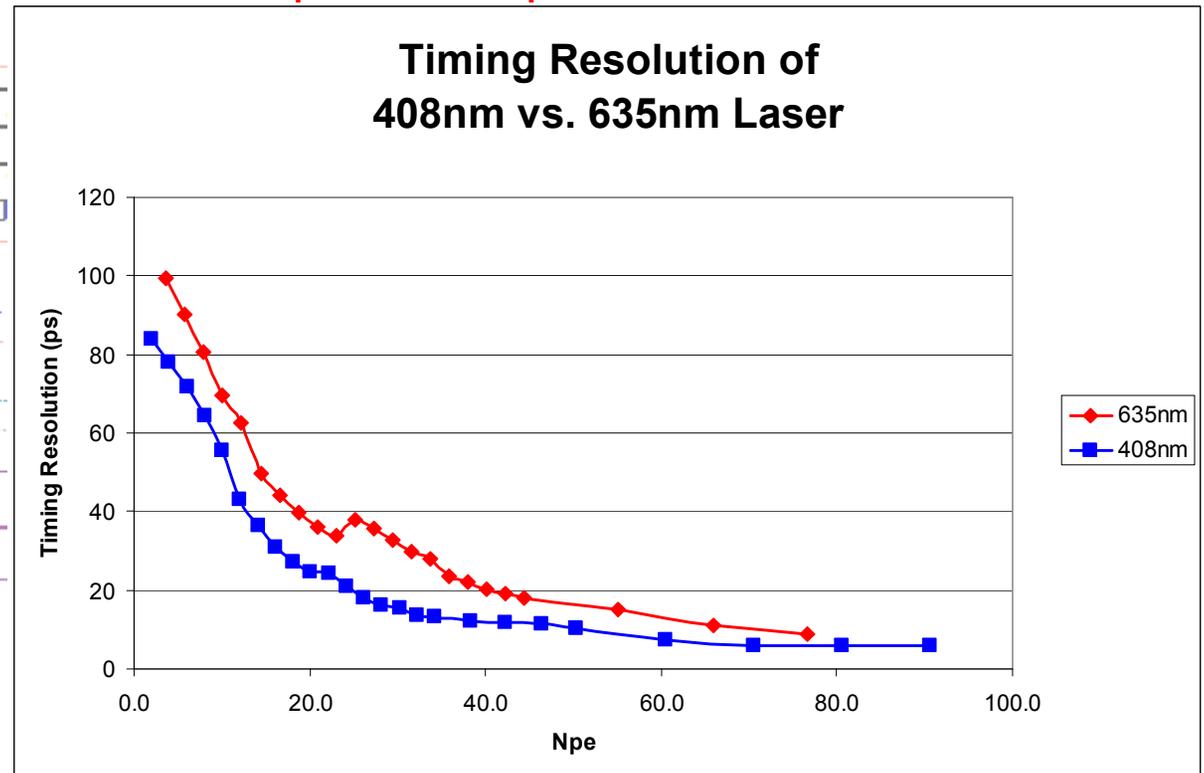
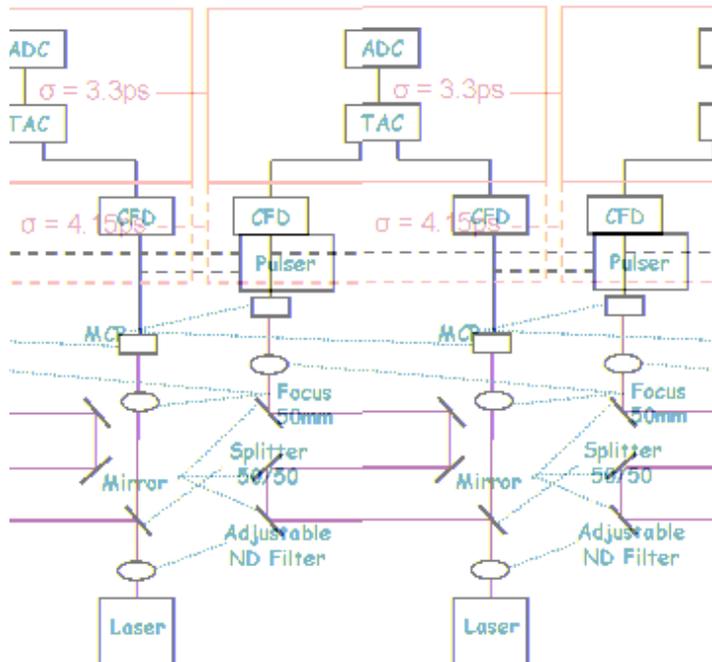
Where we are-much progress!

- Using `off-the-shelf' photo-detectors, clumsy (i.e. inductive, capacitative) anodes, electronics-, but not yet new technologies -are at $\sim 5\text{-}6$ psec resolution with laser bench tests.
- Jerry Va'vra has answered many of the questions we had even a year ago on what limits present performance. Have (crude) models in simulation to compare test results to now
- Much experience with sampling- fast scopes, Gary Varner, Saclay group, Stefan Ritt- up to 6 GHz. Simulation package developed - =>understanding the electronics issues
- First test beam exposure few weeks ago...
- Clock distribution at psec (local) jitter (John Anderson)

Argonne Laser Lab



- Measure Δt between 2 MCP's (i.e. root2 times σ); no corr for elect.
- Results: 408nm
 - 7.5ps at ~50 photoelectrons
- Results: 635nm
 - 18.3ps at ~50 photoelectrons



Understanding the contributing factors to 6 psec resolutions with present Burle/Photonis/Ortec setups- Jerry Vavra's Numbers

1. TTS: 3.8 psec (from a TTS of 27 psec)
2. $\text{Cos}(\theta)_{\text{cherenk}}$ 3.3 psec
3. Pad size 0.75 psec
4. Electronics 3.4 psec

Fermilab Test Beam Goals

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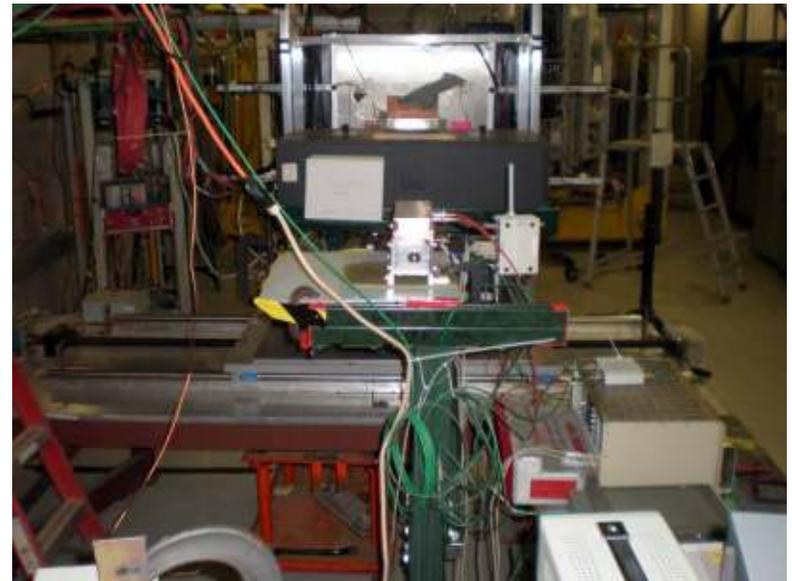
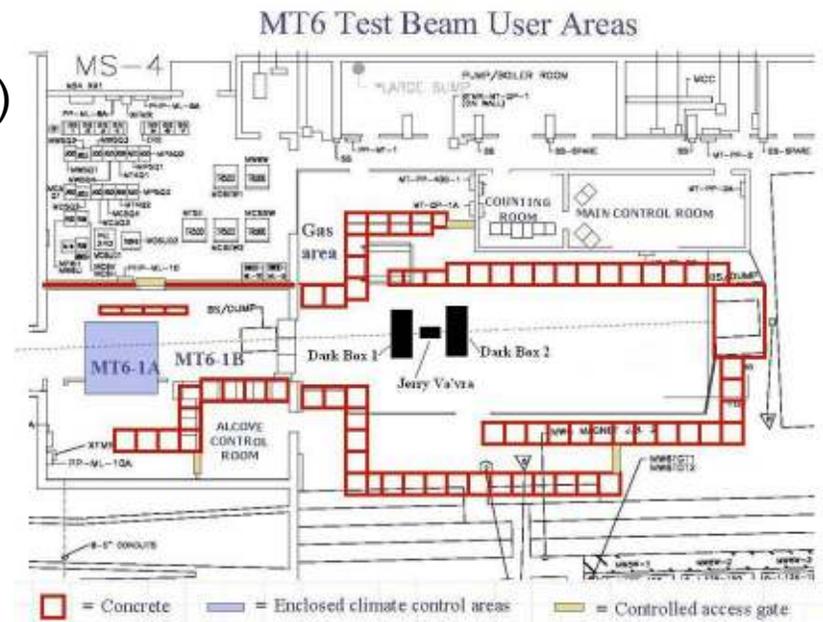
1. To measure the timing resolution of Jerry Va'vra's $10\mu\text{m}$ pore MCPs with new silvered radiator.
2. To measure the timing resolution at known S/N and N_{pe} with $25\mu\text{m}$ pore MCPs to compare with the ANL blue/red laser curves and simulation.
3. To measure the timing resolution of two SiPMs ($3\text{mm} \times 3\text{mm}$ and $1\text{mm} \times 1\text{mm}$).
4. To setup and test a DAQ system for future tests (first run).
5. To obtain waveforms of MCP signals with a fast sampling scope (40Gsamples/sec) to compare to simulation and DAQ



Fermilab Test Beam Setup

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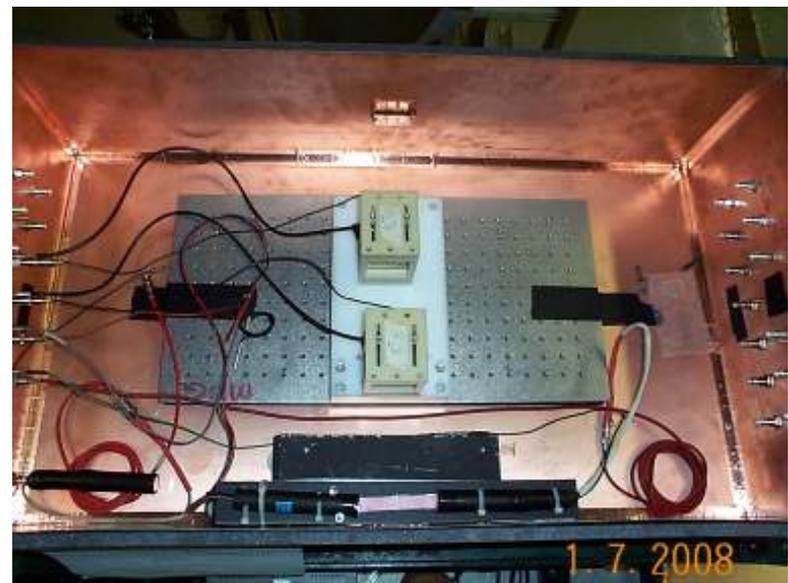
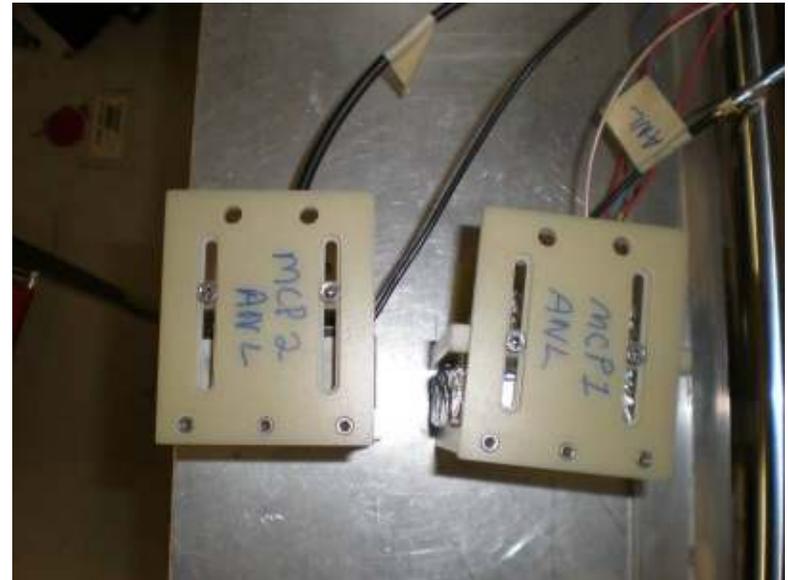
- Three dark boxes (Anatoly- wonderful!)
 - 2mm x 2mm scintillator
 - 2 PMTs for coincidence triggering in each box.
 - 2 MCPs or SiPMs in each box
- 3 DAQ systems
 - DAQ-1
 - uses FERA readout for fast data collection
 - DAQ-2
 - CAMAC
 - Allows other users to quickly connect to our system
 - Tektronix TDS6154C oscilloscope
 - 40 Gsample/sec (total of channels)



Fermilab Test Beam Setup

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- MCP 1 & 2 (dark box 1)
 - Photonis 85011-501
 - 25 μm pore
 - 64 anode (4 anodes tied together and read out)
 - 2 mm quartz face
 - MCP 1 had an updated ground plane, but was very noisy.
 - University of Chicago's MCPs
- MCP 3 & 4 (dark box 2)
 - Photonis 85011-501
 - 25 μm pore
 - 64 anode (4 anodes tied together and read out)
 - 2 mm quartz face
 - Erik Ramberg's MCPs



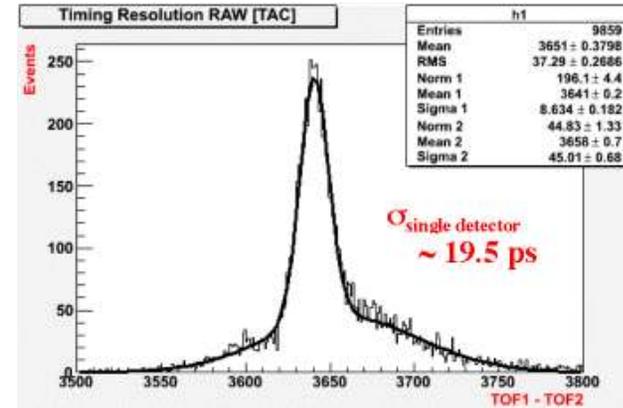
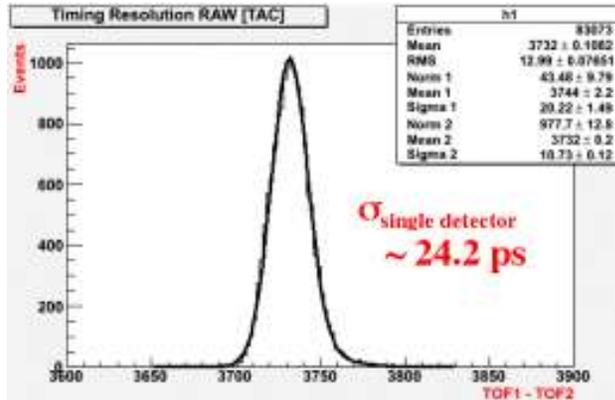
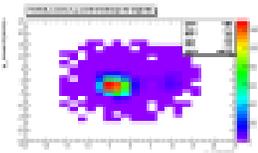
SLAC & Fermilab Test Beam Results

J.Va'vra, SLAC, Camden Ertley (UC/ANL)

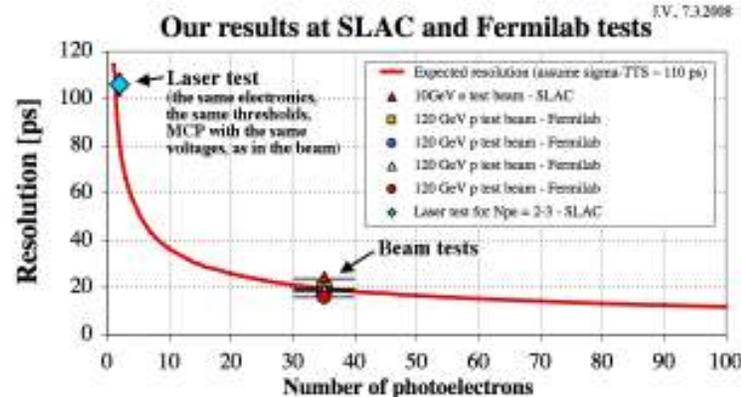
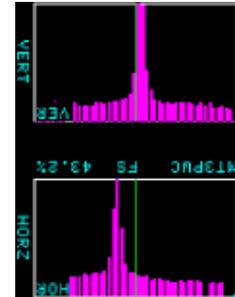
SLAC tests (10 GeV electrons):

Fermilab tests (120 GeV protons):

SLAC
Beam spot
(s ~2-3mm):



Fermilab beam spot
(s ~7mm + halo):

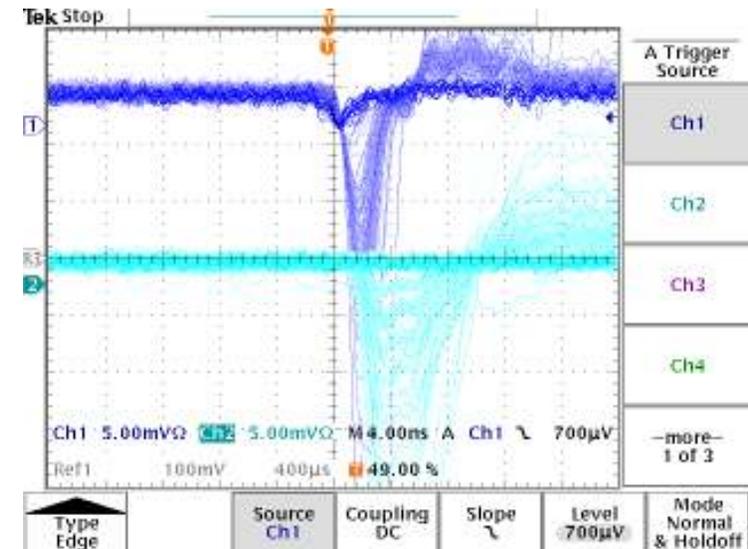
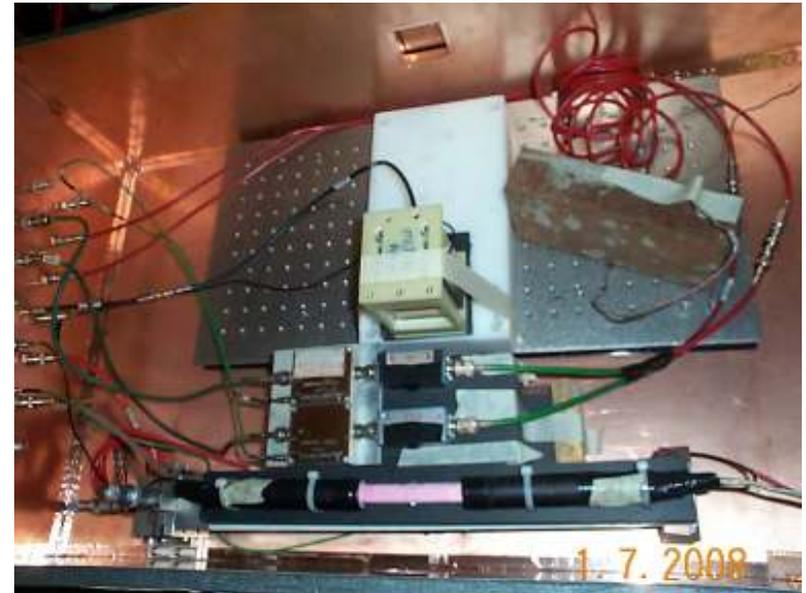


- Aim: (a) low gain to minimize aging effects at SuperB, (b) be linear in a region of $N_{pe} = 30-50$.
- 1-st test at SLAC: typical resolution results: $s_{\text{single detector}} \sim 23-24 \text{ ps}$
- 2-nd test at Fermilab: typical resolution results: $s_{\text{single detector}} \sim 17-20 \text{ ps}$
- Results are consistent with a simple model.
- We have reached a Super-B goal: $\sigma \sim 20 \text{ ps}$

SiPM Fermilab Test Beam Results

Anatoly Ronzhin, FNAL

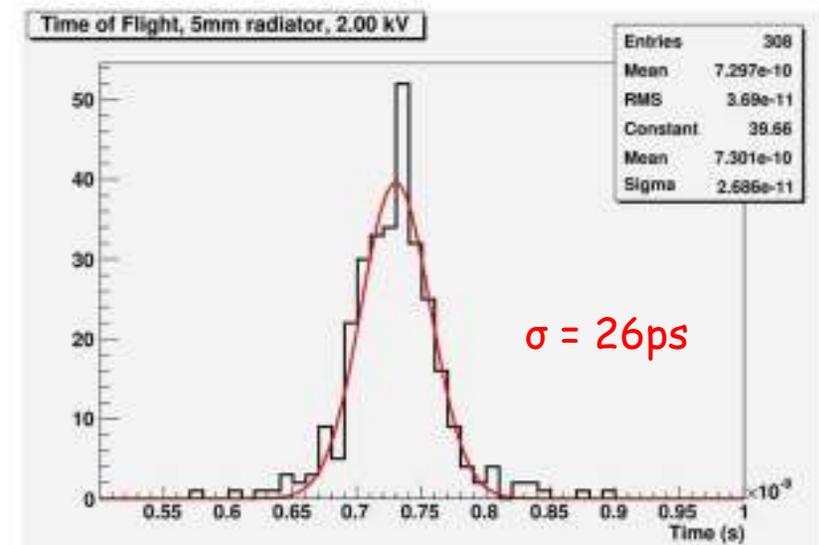
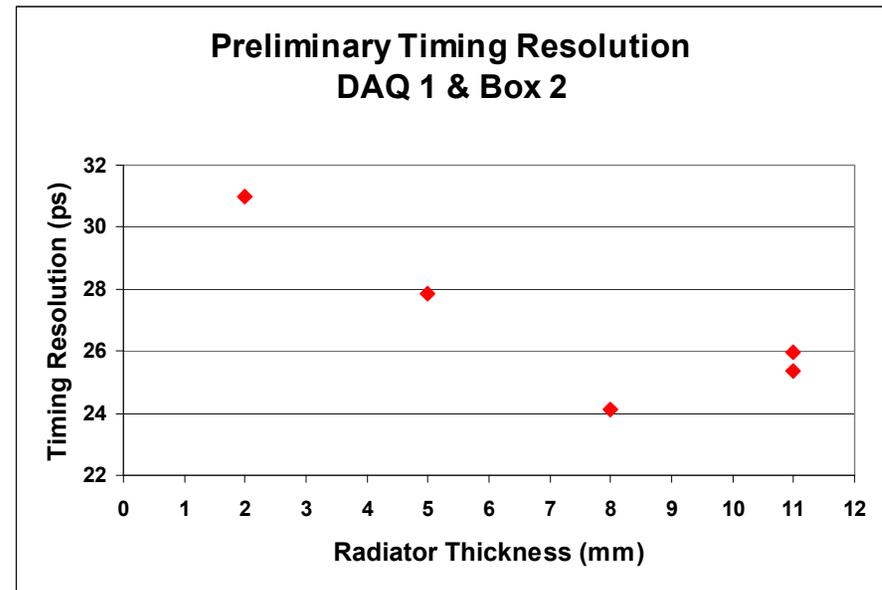
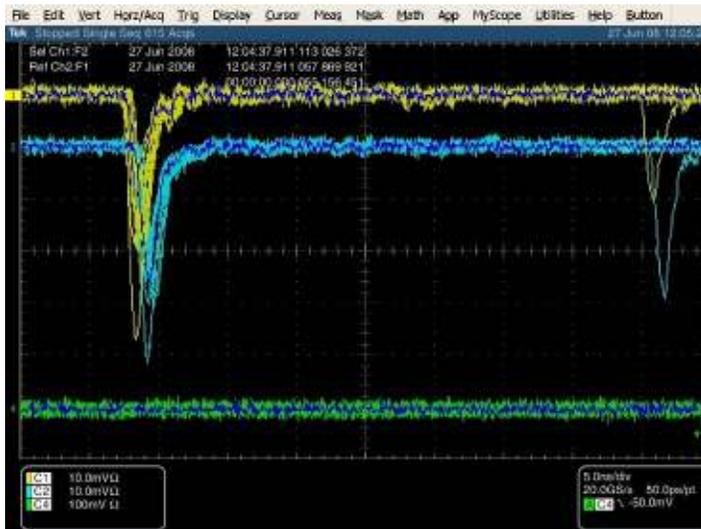
- SiPM 1
 - Hamamatsu 3 x 3 mm²
 - Quartz radiator 6 x 6 x 12 mm³
 - 1.5mm “effective thickness”
 - ~10 photoelectrons
- SiPM 2
 - Hamamatsu 1 x 1 mm²
 - Quartz radiator 6 x 6 x 6 mm³
 - 0.5mm “effective thickness”
 - ~3 photoelectrons
- Obtained 70ps timing resolution
 - Single photoelectron timing is ~121ps for SiPM 2
 - Single photoelectron timing for SiPM 1 will be measured



Fermilab Test Beam Results

- **Preliminary results with DAQ-1**
 - Obtained ~24ps with MCP 3 & 4
 - Cuts on pulse height were made
 - 8mm total radiator
 - 1.9kV
- **Preliminary results with scope.**
 - 8ps intrinsic timing jitter.
 - Obtained ~26ps with MCP 3 & 4
 - 5mm total radiator
 - 2.0 kV

Ch1: MCP3
10mV/div
Ch2: MCP4
10mV/div
5ns/div



Future Work

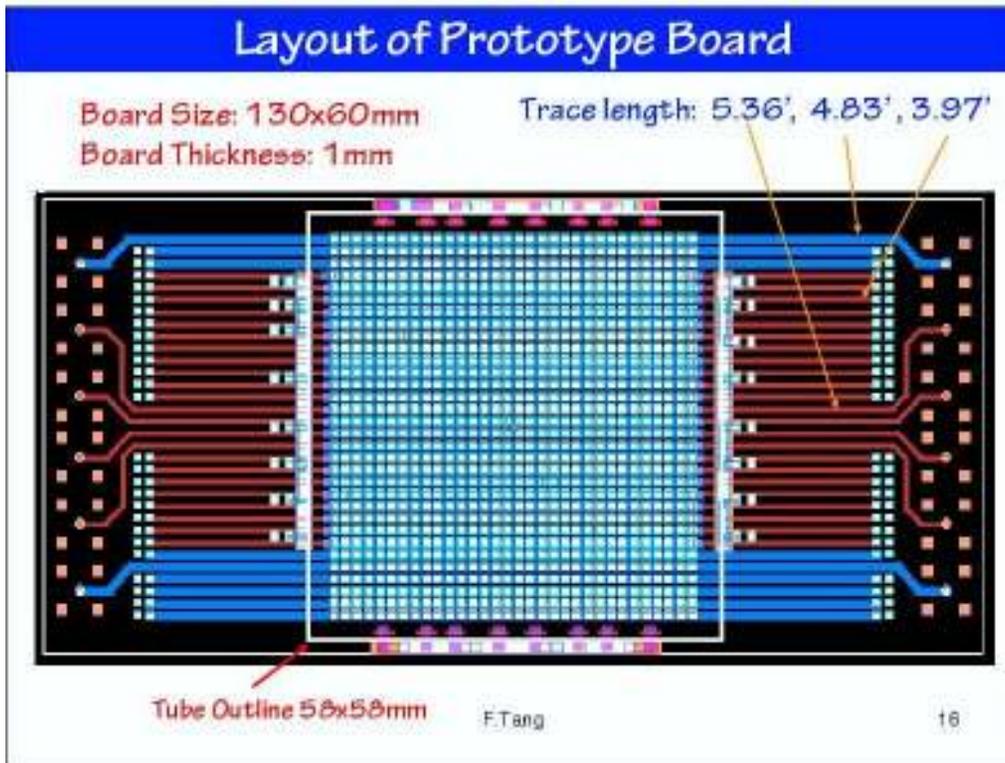
- We would like to schedule future test beam runs as we have new devices and electronics ready
- Same process as now- use laser test-stand for development, validation of simulation- then move to testbeam for comparison with simulation with beam.
 - Changes to the MCPs
 - 10um pore MCPs (two in hand)
 - Transmission-line anodes (low inductance- matched)- in hand
 - Reduced cathode-MCP_IN MCP_OUT-anode gaps- ordered
 - ALD module with integrated anode and capacitive readout- proposed (ANL-LDRD)
 - Changes to electronics readout
 - Add Ritt and/or Varner sampling readouts (interleave 10 GS) –in works
 - First test via SMA; then integrate chips onto boards?
 - Development of 40 GS CMOS sampling in IBM 8RF (0.13micron)- proposal in draft
 - New applications/geometries (LHC/Albrow)-proposed
 - Test timing between two similar SiPMs, new devices

Jerry's #'s re-visited : Solutions to get to <several psec resolution. ¹⁹

- 1. TTS: 3.8 psec (from a TTS of 27 psec)**
MCP development- reduce TTS- smaller pores, smaller gaps, filter chromaticity, ANL atomic-deposition dynodes and anodes.
- 2. Cos(theta)_cherenk 3.3 psec**
Same shape- spatial distribution (e.g. strips measure it)
- 3. Pad size 0.75 psec-**
Transmission-line readout and shape reconstruction
- 4. Electronics 3.4 psec –**
fast sampling- should be able to get < 1psec (simulation)

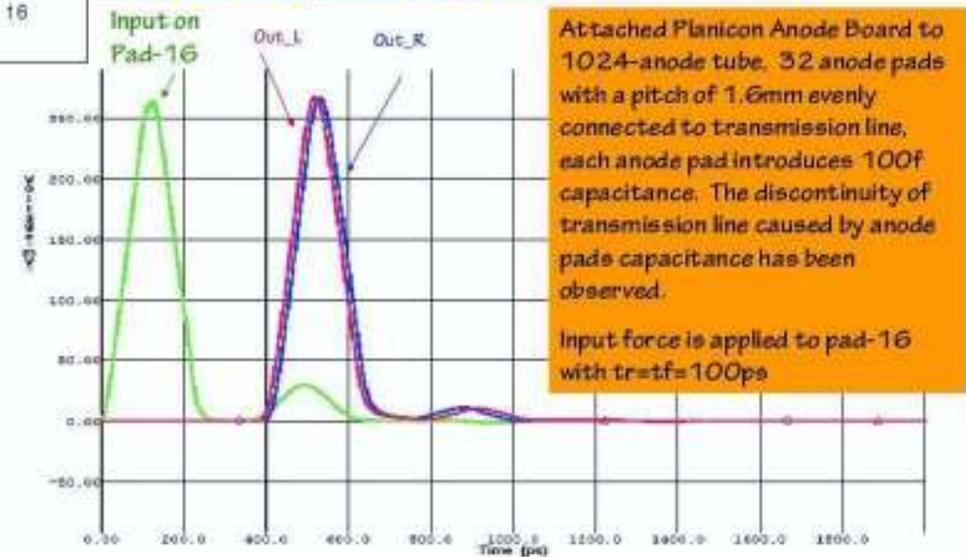
New Anode Readout-

Get time AND position from reading both ends of transmission lines



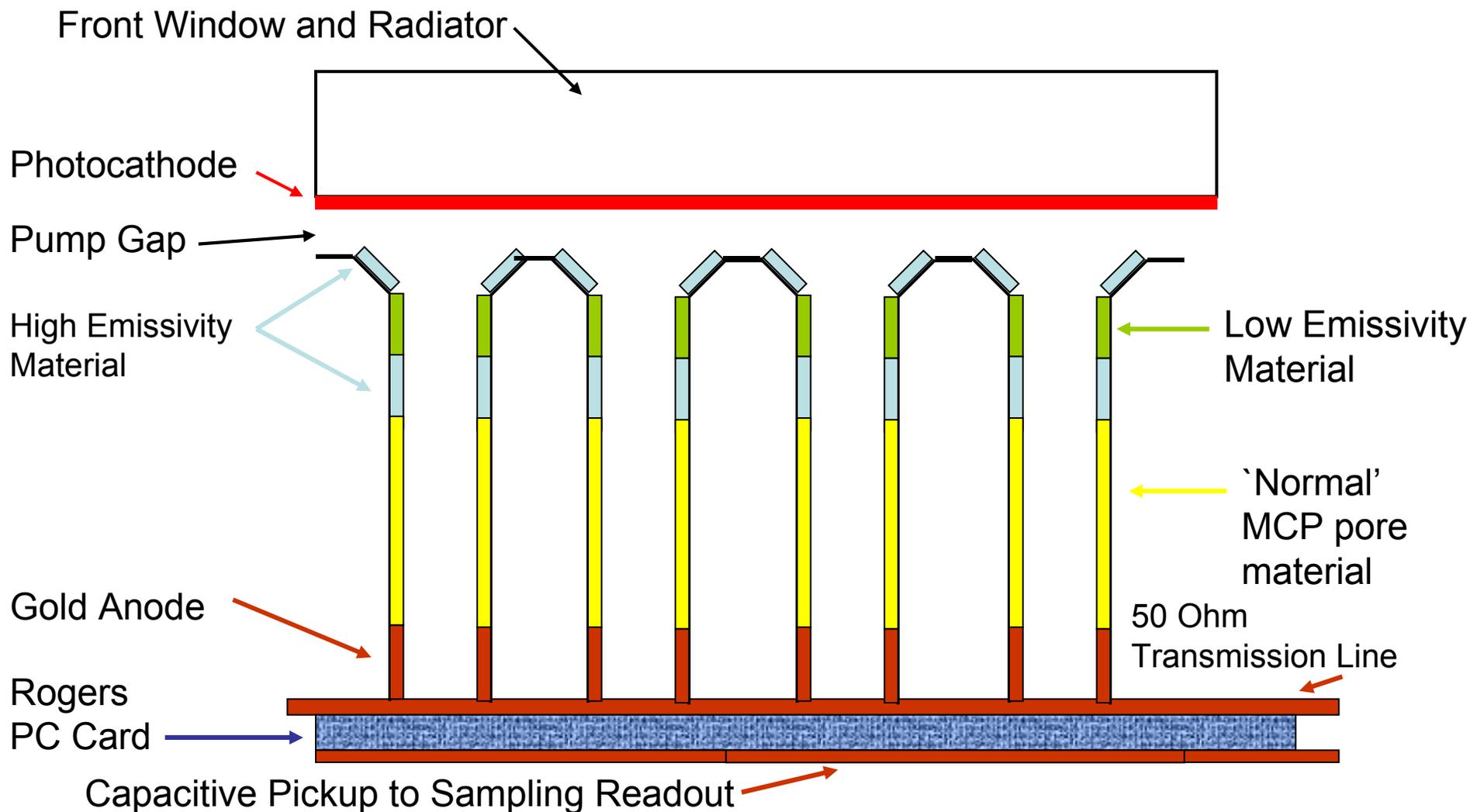
32 50 ohm transmission lines on 1.6 mm centers (Tang); attach to 1024 anode pads (Sellberg)

T32 Responses with Anode-Stubs

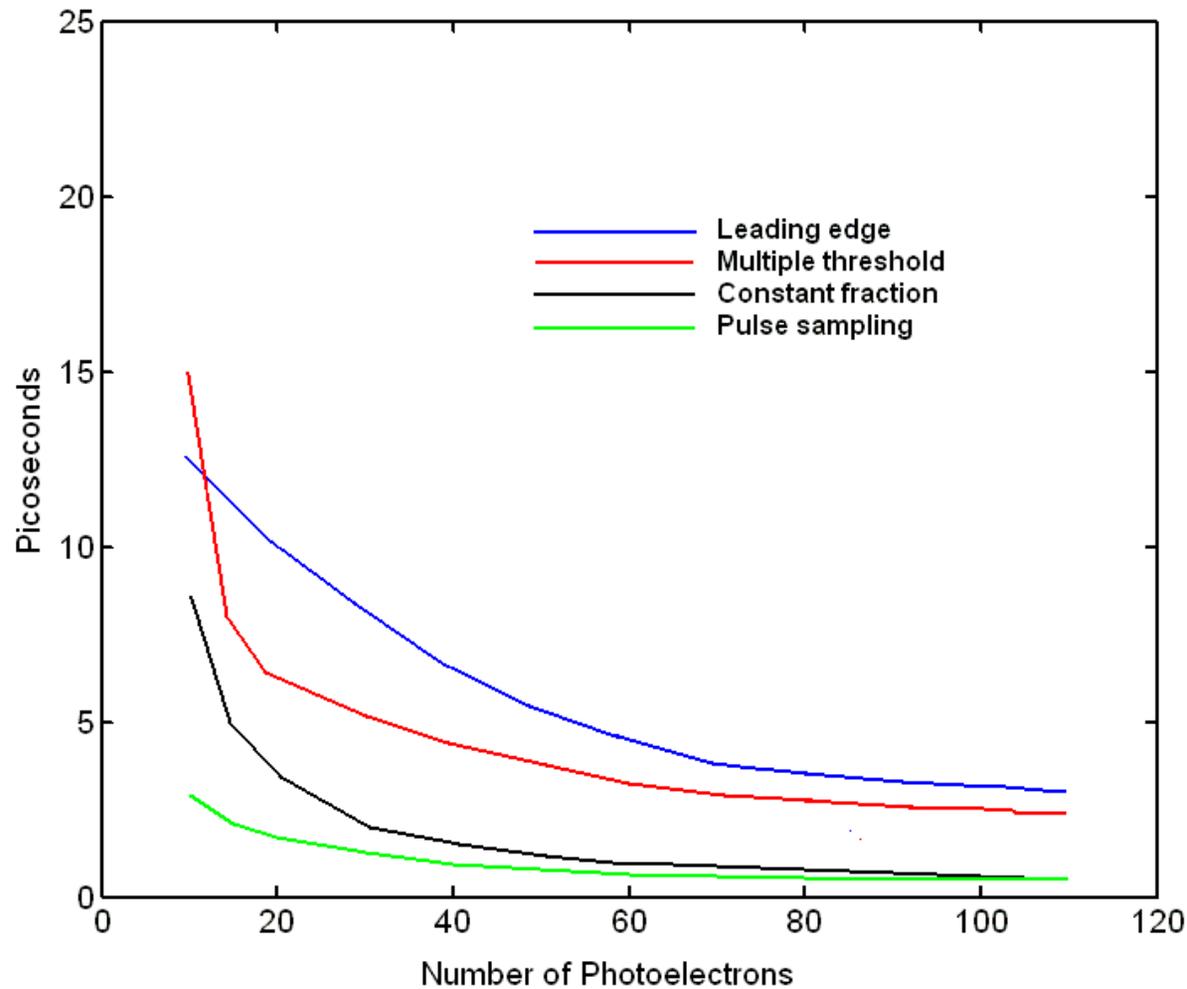


Simulation of loaded transmission line
With mock MCP pulse and anode pads (Tang)

Psec Large-area Micro-Channel Plate Panel (MCP) - LDRD proposal to ANL (with Mike Pellin/MSD)



Electronics Simulation- development of multi-channel low-power cheap (CMOS) readout



S/N=80

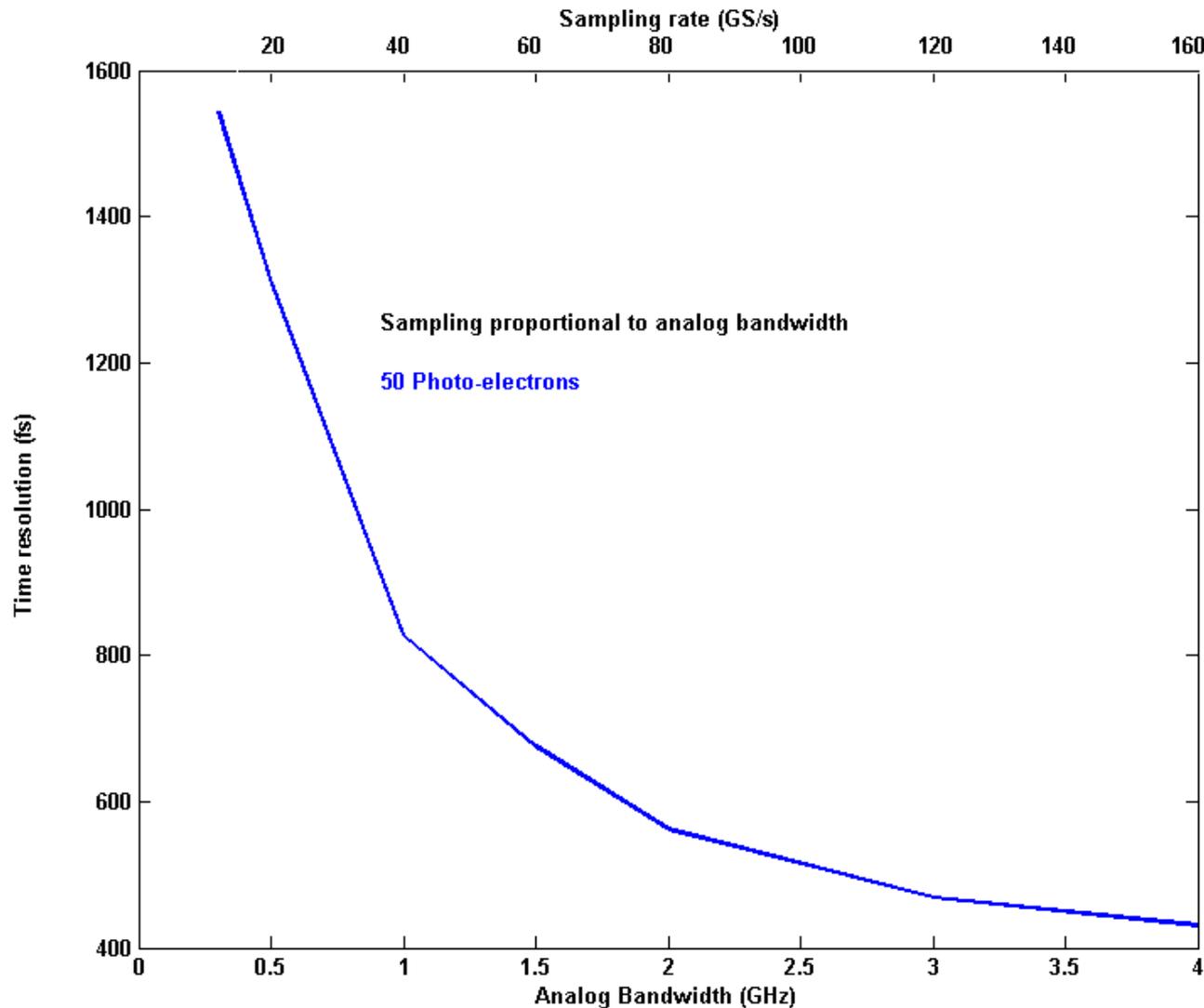
ABW= 1 GHz

Synthesized
MCP signal

8 bit A-to-D

Jean-Francois Genat

Electronics Simulation- Sampling analog bandwidth on input at fixed S/N and sampling/ABW ratio



S/N=80
Synthesized MCP
signal
8 bit A-to-D

Jean-Francois Genat

Summary

- Successful first run- got Jerry's Super-B data, SiPM data, 25-micron MCP data with radiators
- First look at MCP data makes it plausible that it falls on our laser teststand and simulation curves for S/N, Npe- analysis in works
- Got safety, dark-boxes, cables, DAQ, Elog, great bunch of collaborators, new students, etc. in place- very good start!
- Have new devices/readouts in the works- start of a program.
- We're really grateful to Fermilab and all who support the Mtest testbeam.